

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YU-PIN LIU	10/19/2009
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	FOXSEMICON INTEGRATED TECHNOLOGY, INC.
<b>Street Address:</b>	No. 16, Ke-Jung Rd., Science-Based Industrial Park
<b>City:</b>	Chu-Nan, Miao-Li Hsien
<b>State/Country:</b>	TAIWAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29346021
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	US28305
<b>NAME OF SUBMITTER:</b>	Raymond J. Chew
<b>Total Attachments: 2</b> source=US28305091019ASM#page1.tif source=US28305091019ASM#page2.tif	

**CH \$40.00 29346021**

## ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1. YU-PIN LIU , residing at Chu-Nan, Miao-Li, Taiwan
2. \_\_\_\_\_ , residing at \_\_\_\_\_
3. \_\_\_\_\_ , residing at \_\_\_\_\_
4. \_\_\_\_\_ , residing at \_\_\_\_\_
5. \_\_\_\_\_ , residing at \_\_\_\_\_
6. \_\_\_\_\_ , residing at \_\_\_\_\_
7. \_\_\_\_\_ , residing at \_\_\_\_\_
8. \_\_\_\_\_ , residing at \_\_\_\_\_

hereby sell(s), assign(s) and transfer(s) unto: **FOXSEMICON INTEGRATED TECHNOLOGY, INC.** having a principal place of business at **No. 16, Ke-Jung Rd., Science-Based Industrial Park, Chu-Nan, Miao-Li Hsien, Taiwan 350, R.O.C.** hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as **HEAT DISSIPATION DEVICE** for which the undersigned

[     ] previously executed --- Ser. No. \_\_\_\_\_ and filing date of \_\_\_\_\_  
[ x ] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1. Yu-Pin Liu Oct. 19, 2009 \_\_\_\_\_  
YU-PIN LIU Date Witness

2. \_\_\_\_\_  
Date Witness

3. \_\_\_\_\_  
Date Witness

4. \_\_\_\_\_  
Date Witness

5. \_\_\_\_\_  
Date Witness

6. \_\_\_\_\_  
Date Witness

7. \_\_\_\_\_  
Date Witness

8. \_\_\_\_\_  
Date Witness

9. \_\_\_\_\_  
Date Witness